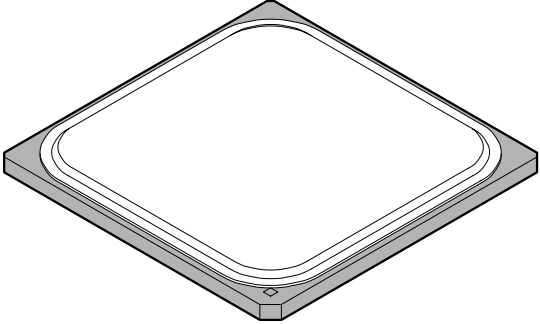
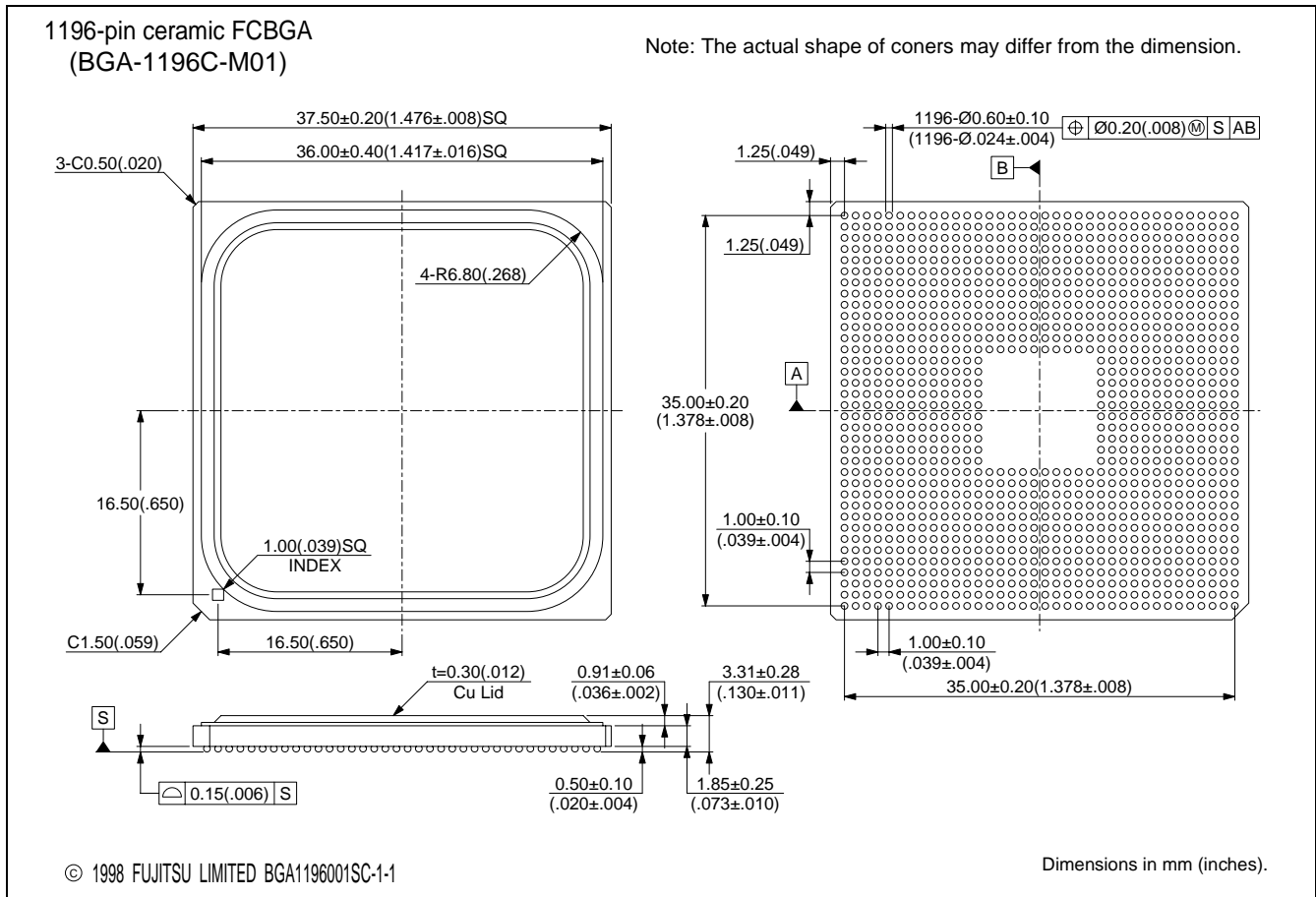


BGA-1196C-M01

<p>1196-pin ceramic FCBGA</p>  <p>(BGA-1196C-M01)</p>	Lead pitch	1.00 mm	
	Package width × package length	37.50 × 37.50 mm	
	Lead shape	Ball	
	Sealing method	Under fill	
	Mounting height	3.59 mm Max	



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